



-30V P+P Channel Enhancement Mode MOSFET

Description

The AP4959A uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

V_{DS} = -30V I_D =-18A

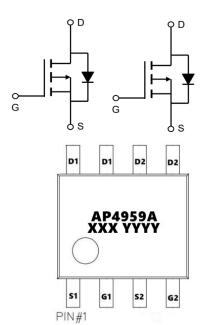
 $R_{DS(ON)} < 18m\Omega @ V_{GS} = -10V$ (Type: 12.5m Ω)

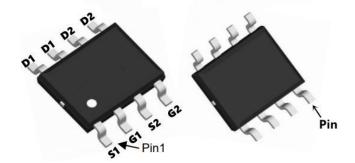
Application

Lithium battery protection

Wireless impact

Mobile phone fast charging





Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AP4959A	SOP-8L	ΑΡ4959Α ΧΧΧ ΥΥΥΥ	300

电话:0769-89027776/81885205/81885153

Absolute Maximum Ratings (TC=25°C unless otherwise noted)

Symbol	Parameter Rating		Units	
VDS	Drain-Source Voltage	-30	V	
VGS	Gate-Source Voltage	±20	V	
I₀@T _A =25℃	Continuous Drain Current, V _{GS} @ -10V ¹ -18		А	
I₀@T _A =70°C	Continuous Drain Current, V _{GS} @ -10V ¹	Continuous Drain Current, V _{GS} @ -10V ¹ -11		
IDM	Pulsed Drain Current ² -48		А	
EAS	Single Pulse Avalanche Energy ³ 168		mJ	
P₀@T _A =25℃	Total Power Dissipation ⁴ 310		W	
TSTG	Storage Temperature Range -55 to 150		°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	
R₀JA	Thermal Resistance Junction-Ambient ¹	Ambient ¹ 85		
R₀JC	Thermal Resistance Junction-Case ¹	e ¹ 4.5		



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Electrical Characteristics (TJ=25°C, unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units	
V(BR)DSS	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D = -250µA	-30	-32.5	-	V	
IDSS	Zero Gate Voltage Drain Current	V _{DS} = -30V, V _{GS} =0V,	-	-	-1	μA	
IGSS	Gate to Body Leakage Current	V _{DS} =0V, V _{GS} = ±20V	-	-	±100	nA	
VGS(th)	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D = -250μA	-1.2	-1.5	-2.5	V	
	Static Drain-Source on-Resistance note3	V _{GS} = -10V, I _D = -10A	-	12	18		
RDS(on)		V _{GS} = -4.5V, I _D = -5A	-	18	25	mΩ	
Ciss	Input Capacitance		-	2130	-	pF	
Coss	Output Capacitance	V _{DS} = -24V, V _{GS} =10V, f=1.0MHz	-	280	-	pF	
Crss	Reverse Transfer Capacitance		_	252	-	pF	
Qg	Total Gate Charge	V _{DS} = -24V, I _D = -1A, V _{GS} = -10V	-	22	-	nC	
Qgs	Gate-Source Charge		-	4	-	nC	
Q_gd	Gate-Drain("Miller") Charge		-	5.8	-	nC	
td(on)	Turn-on Delay Time		-	9	-	ns	
tr	Turn-on Rise Time	V _{DD} = -24V, I _D = -1A,	-	13	-	ns	
td(off)	Turn-off Delay Time	V_{GS} = -10V, R_{GEN} =7.0 Ω	-	48	-	ns	
t _f	Turn-off Fall Time		-	20	-	ns	
IS	Maximum Continuous Drain to Source Diode Forward Current		-	-	-29.5	Α	
ISM	Maximum Pulsed Drain to Source I	Diode Forward Current	-	-	-44	Α	
VSD	Drain to Source Diode Forward Voltage	V _{GS} =0V, I _S = -1A	-	-0.74	-1.2	V	

Note :

 $1_{\mbox{\tiny N}}$ The data tested by surface mounted on a 1 inch 2 $\,$ FR-4 board with 2OZ copper.

 $2\,{\scriptstyle \sim}\,$ The data tested by pulsed , pulse width .The EAS data shows Max. rating .

 $3\,{\scriptstyle \sim}\,$ The power dissipation is limited by 175 $^\circ\!{\rm C}\,$ junction temperature

4. The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.



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Typical Characteristics

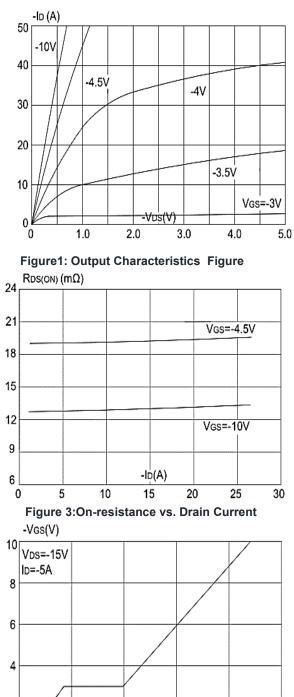
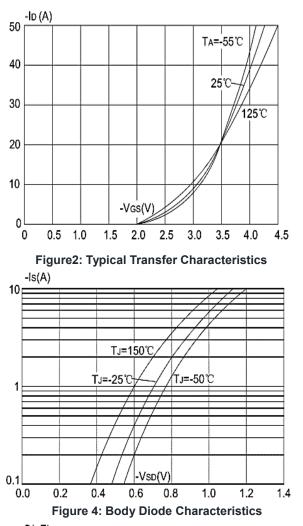


Figure 5: Gate Charge Characteristics

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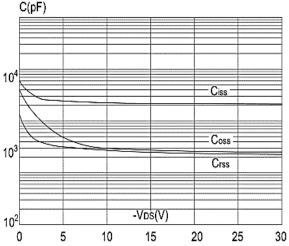


Figure 6: Capacitance Characteristics

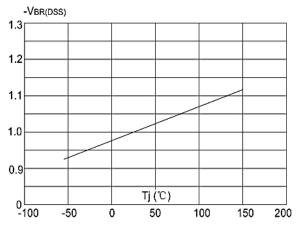
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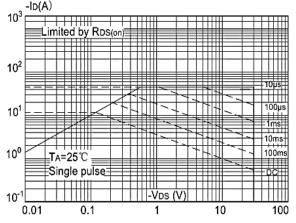
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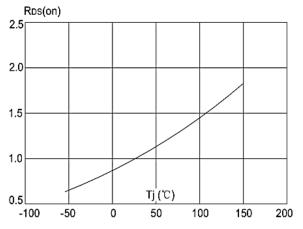
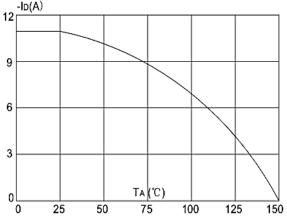


Figure 8: Normalized on Resistance vs. Junction Temperature





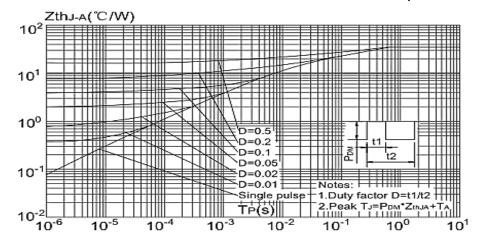
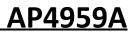


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

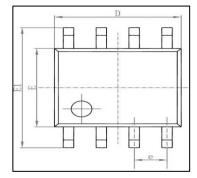


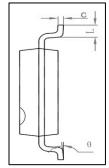


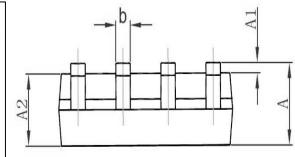


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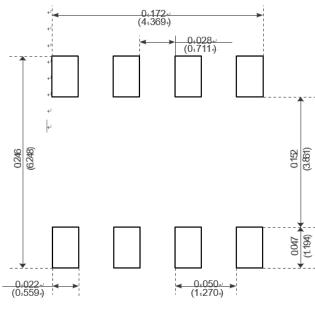
Package Mechanical Data-SOP-8L







Symbol	Dimensions Ir	n Millimeters	Dimensions	In Inches
	Min	Max	Min	Max
A	1.350	1. 750	0. 053	0.069
A1	0.100	0. 250	0.004	0. 010
A2	1.350	1.550	0. 053	0. 061
b	0. 330	0. 510	0.013	0. 020
с	0.170	0. 250	0.006	0. 010
D	4. 700	5. 100	0. 185	0. 200
E	3.800	4.000	0. 150	0. 157
E1	5.800	6.200	0. 228	0. 244
е	1.270	(BSC)	0. 050	(BSC)
L	0.400	1.270	0.016	0.050
θ	0 °	8°	0°	8°



Recommended Minimum Pads